

High Precision Bulk Metal® Foil Surface Mount Voltage Divider

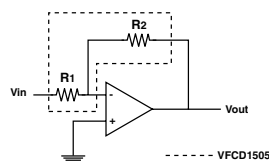
TCR Tracking of <0.5 ppm/°C, Tolerance Match of 0.01%
and Stability of ±0.005% (50 ppm)

FEATURES

- Temperature coefficient of resistance (TCR):
Absolute: (table 1)
±0.05 ppm/°C (typical 0°C to +60°C)
±0.2 ppm/°C (typical -55°C to +125°C, +25°C ref.)
Tracking: (table 1)
0.1 ppm/°C typical
- Resistance range: 1K to 10K
- Power coefficient tracking: "ΔR due to self heating"
5 ppm at rated power
- Short time overload: ±0.005%
- Tolerance: absolute and resistance ratio: to 0.01%
- Load life stability (0.1 W at 70°C, 2000 h)
Absolute: 0.01%
Ratio: 0.005%
- Electrostatic discharge (ESD) up to 25 000 V
- Power rating at 70°C: entire package: 0.1 W, divided
between the two resistors proportionally to their value
- Non-inductive, non-capacitive design
- Thermal EMF: 0.05 μV/°C typical
- Current noise: <-40 dB
- Rise time: 1 ns effectively no ringing
- Non inductive: <0.08 μH
- Voltage coefficient: <0.1 ppm/V
- Non hot spot design
- Terminal finish: lead (Pb)-free or tin/lead alloy
- For better performances please contact us
- Prototypes quantities available in just 5 working days
or sooner. For more information, please contact:
foil@vishaypg.com

APPLICATIONS

- Instrumentation amplifiers
- Bridge networks
- Differential amplifiers
- Ratio arms in bridge circuits
- Medical and test equipment
- Military
- Airborne etc



Note

* This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS compliant. Please see the information/tables in this datasheet for details.



Bottom
View



RoHS*
COMPLIANT

INTRODUCTION

Bulk Metal® Z-Foil (BMZF) technology out-performs all other resistor technologies available today for applications that require ultra high precision and ultra high stability.

The new Z-Foil technology provides a significant reduction of the resistive element's sensitivity to changes of temperature due to ambient temperature variations (TCR) and to self heating when power is applied (power coefficient).

Model **VFCD1505** offers low TCR (both absolute and tracking), excellent load life stability, tight tolerance, excellent ratio stability, low thermal EMF and low current noise, all in one package. 0.05 ppm/°C absolute TCR removes errors due to temperature gradients.

The **VFCD1505** surface mount divider provides tight tolerance matching and TCR tracking between 2 resistors simultaneously etched on one piece of foil on a common substrate. The electrical specifications of this integrated construction offers improved performances and better real estate utilization over discrete resistors and matched pairs.

Our application engineering department is available to advise and make recommendations for non-standard technical requirements and special applications, please contact us.

Figure 1 – Power Derating Curve

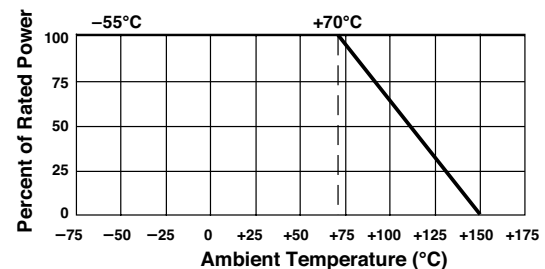


Figure 2 – Schematic

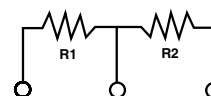


Table 1 – Resistance Values/Ratio and TCR Characteristics

POPULAR VALUES	VCODES	ABSOLUTE TCR (-55°C TO +125°C, +25°C REF.)		TCR TRACKING		TOLERANCE MATCHING
		TYPICAL	MAXIMUM	TYPICAL	MAXIMUM	
10K/10K	V0001	±0.2 ppm/°C	±1 ppm/°C	0.1 ppm/°C	0.5 ppm/°C	0.01%
5K/5K	V0002					
1K/1K	V0004					
2K/2K	V0059					
5K/10K	V0005	±0.2 ppm/°C	±1 ppm/°C	0.4 ppm/°C	1.0 ppm/°C	0.01%
2.5K/10K	V0060					
1K/9K	V0056	±0.2 ppm/°C	±1 ppm/°C	0.4 ppm/°C	1.0 ppm/°C	0.02%
1K/10K	V0064					

Note

Additional ratios are available. For the relevant VCODES for ordering, please contact application engineering using the footer below.

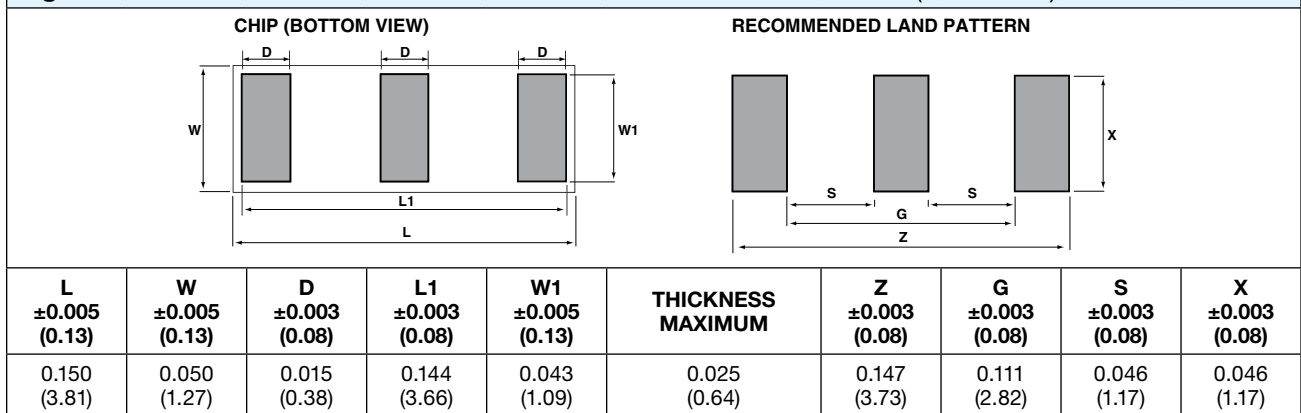
Table 2 – Typical Performance Specifications

TEST	MIL-PRF-55342H CHARACTERISTIC E ΔR LIMITS ⁽¹⁾	VFCD1505 ΔRATIO
Thermal shock	0.10%	0.005% (50 ppm)
Low temperature operation	0.10%	0.005% (50 ppm)
Short time overload	0.10%	0.005% (50 ppm)
High temperature exposure	0.10%	0.01% (100 ppm)
Resistance to soldering heat	0.20%	0.01% (100 ppm)
Moisture resistance	0.20%	0.005% (50 ppm)
Load life (ratio stability)	-	0.005% (50 ppm)
Maximum working voltage for each element	22 V	
Weight	10 mg	
Packaging	Waffle pack standard, tape and reel available	

Note

⁽¹⁾ ΔR's plus additional 0.01 Ω for measurement error

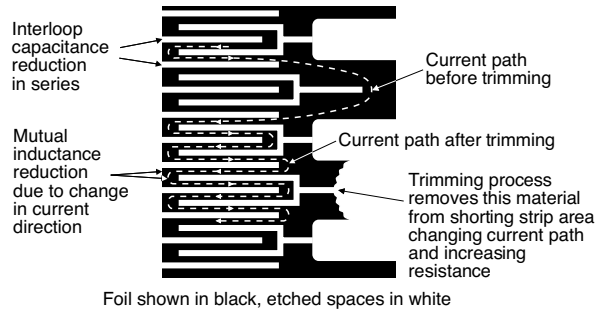
Figure 3 – Model VFCD1505 Dimensions and Land Pattern in inches (millimeters)



Notes

Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction
Vacuum pick up is recommended for handling
Soldering iron is not applicable

Figure 4 – Trimming to Values



Note

To acquire a precision resistance value, the Bulk Metal® Foil chip is trimmed by selectively removing built-in “shorting bars.” To increase the resistance in known increments, marked areas are cut, producing progressively smaller increases in resistance. This method reduces the effect of “hot spots” and improves the long-term stability of Bulk Metal® Foil resistors.

Figure 3 – Typical Resistance/Temperature Curve (for more details, see table 1)

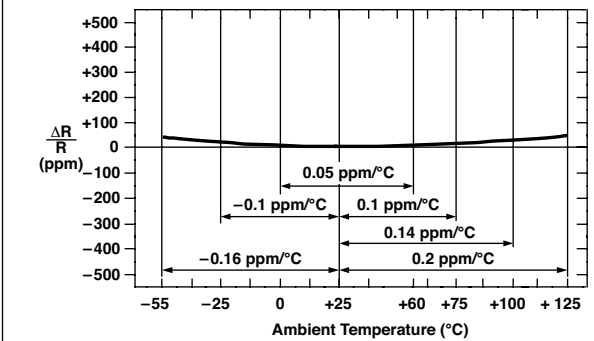
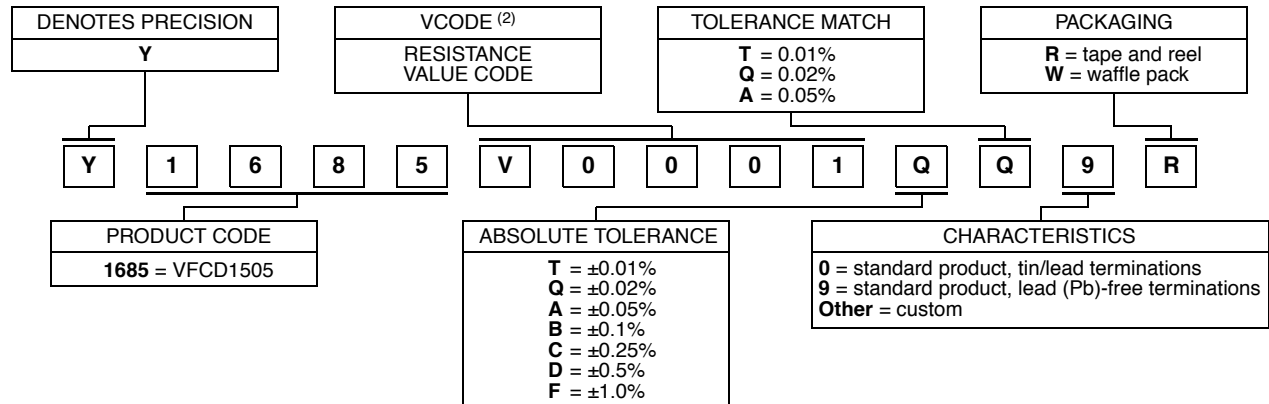


Table 3 – Global Part Number Information⁽¹⁾

NEW GLOBAL PART NUMBER: Y1685V0001QQ9R (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y1685 V0001 Q Q 9 R:

TYPE: VFCD1505
VALUES: 10K/10K
ABSOLUTE TOLERANCE: ±0.02%
TOLERANCE MATCH: 0.02%
TERMINATION: lead (Pb)-free
PACKAGING: tape and reel

HISTORICAL PART NUMBER: VFCD1505 10K/10K TCR0.2 Q Q S T (will continue to be used)

VFCD1505	10K/10K	TCR0.2	Q	Q	S	T
MODEL	OHMIC VALUE	TCR CHARACTERISTIC	ABSOLUTE TOLERANCE	TOLERANCE MATCH	TERMINATION	PACKAGING
VFCD1505	R₁ = 10 kΩ R₂ = 10 kΩ		T = ±0.01% Q = ±0.02% A = ±0.05% B = ±0.1% C = ±0.25% D = ±0.5% F = ±1.0%	T = 0.01% Q = 0.02% A = 0.05%	S = lead (Pb)-free B = tin/lead alloy	T = tape and reel W = waffle pack

Note

⁽¹⁾ Application engineering release: for non-standard requests, please contact application engineering
⁽²⁾ For examples of VCODES see table 1